

Dual P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
- 30	0.036 at V _{GS} = - 10 V	- 5.2		
	0.055 at V _{GS} = - 4.5 V	- 4.2		

FEATURES

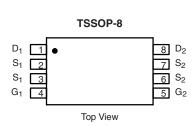
- Halogen-free
- TrenchFET® Power MOSFETs

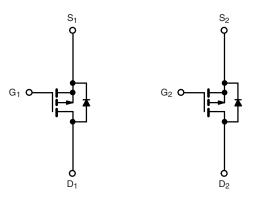


RoHS COMPLIANT

APPLICATIONS

- Load Switch
- · Battery Switch





P-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	- 30		V	
Gate-Source Voltage		V _{GS}	± 20			
Continuous Drain Current (T _{.1} = 150 °C) ^a	T _A = 25 °C	I _D	- 5.2	- 4.1		
Continuous Diain Current (1) = 150 C)	T _A = 70 °C		- 4.2	- 3.6		
Pulsed Drain Current (10 µs Pulse Width)		I _{DM}	- 30		Α Α	
Continuous Source Current (Diode Conduction) ^a		I _S	- 1.0	- 0.70		
Manimum Davian Dissipation ²	T _A = 25 °C	P _D	1.14	0.83	w	
Maximum Power Dissipation ^a	T _A = 70 °C		0.73	0.53		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manifestore baseding to Applicated	t ≤ 10 s	- R _{thJA}	86	110	°C/W
Maximum Junction-to-Ambient ^a	Steady State		124	150	
Maximum Junction-to-Foot	Steady State	R _{thJF}	52	65	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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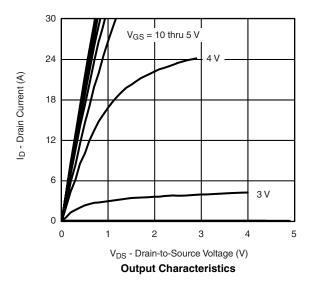
SPECIFICATIONS $T_J = 25^{\circ}$ Parameter	Symbol	Test Conditions Min		Тур.	Max.	Unit	
Static	,		l				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 3.0	٧	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 1	μΑ	
	I _{DSS}				- 10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 15			Α	
Drain-Source On-State Resistance ^a	В	V _{GS} = - 10 V, I _D = - 4.7 A		0.036		0	
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.8 A		0.055		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 4.7 A		14		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 1.0 A, V _{GS} = 0 V		- 0.74	- 1.1	٧	
Dynamic ^b	•		•	·!	1		
Total Gate Charge	Qg			13	20		
Gate-Source Charge	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -4.7 \text{ A}$		3		nC	
Gate-Drain Charge	Q_{gd}			5.8			
Gate Resistance	R_g	f = 1.0 MHz		4.6		Ω	
Turn-On Delay Time	t _{d(on)}			13	20		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 15 Ω		14	22		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 1 A, $V_{GEN}=$ - 10 V, $R_G=6~\Omega$		52	80	ns	
Fall Time	t _f			26	40		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.0 A, dl/dt = 100 A/μs		40	60		

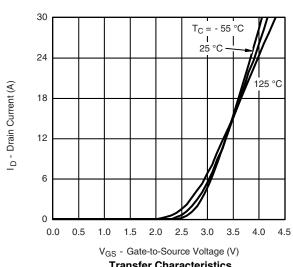
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



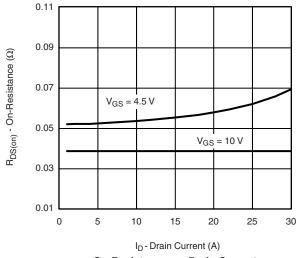


Transfer Characteristics

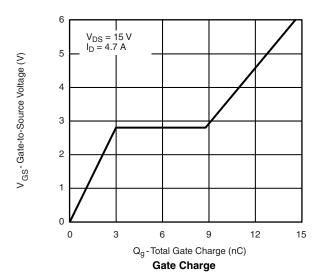
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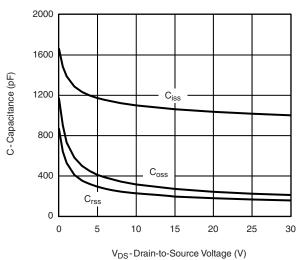


On-Resistance vs. Drain Current



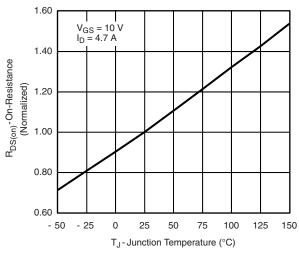
T_J = 150 °C

 $\label{eq:VSD-Source-to-Drain Voltage} V_{SD}\text{-}\,\text{Source-to-Drain Voltage} \ \, \\ \textbf{Source-Drain Diode Forward Voltage} \ \, \\$

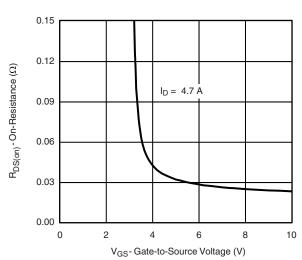


On a self-condition





On-Resistance vs. Junction Temperature



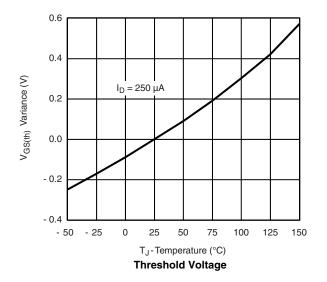
On-Resistance vs. Gate-to-Source Voltage

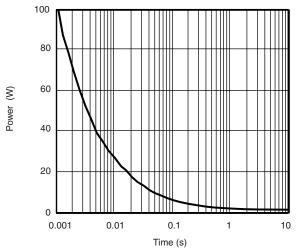
30

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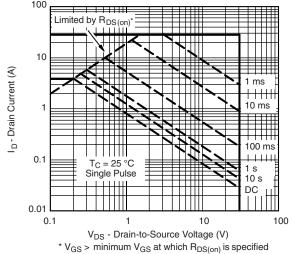


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

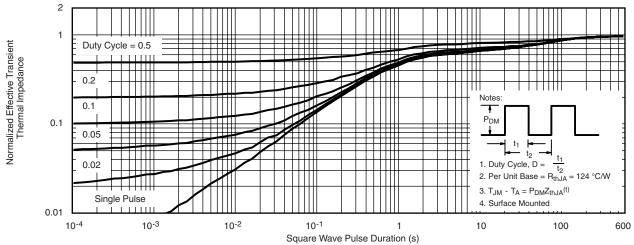




Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Case

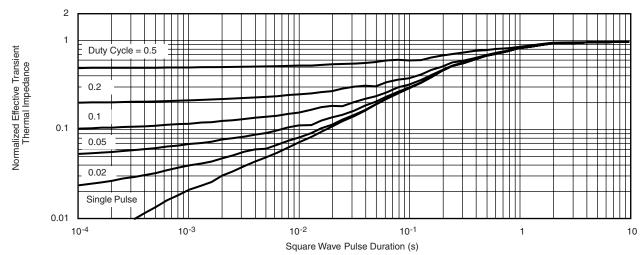


Normalized Thermal Transient Impedance, Junction-to-Ambient

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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